



Harrogate Winter Seminar 2017- Sponsored by Fineline VAR Ltd

Developments in Photo-plotters, UV Direct Imaging and Automatic Visual Inspection (AVI) Systems

5th of December 2017
Jean-paul BIRRAUX
Sales & Marketing Manager
sales@firsteie.com





Overview and key facts

Company Profile

Founded in 1980

Reincorporated in 1993, +20 years

CEO M. Gregory STOECKLI

Installed Base +1000 units World Wide

Factory 1200 sqm in Nyon, Switzerland



Global Network 18 Distributors covering 25 countries

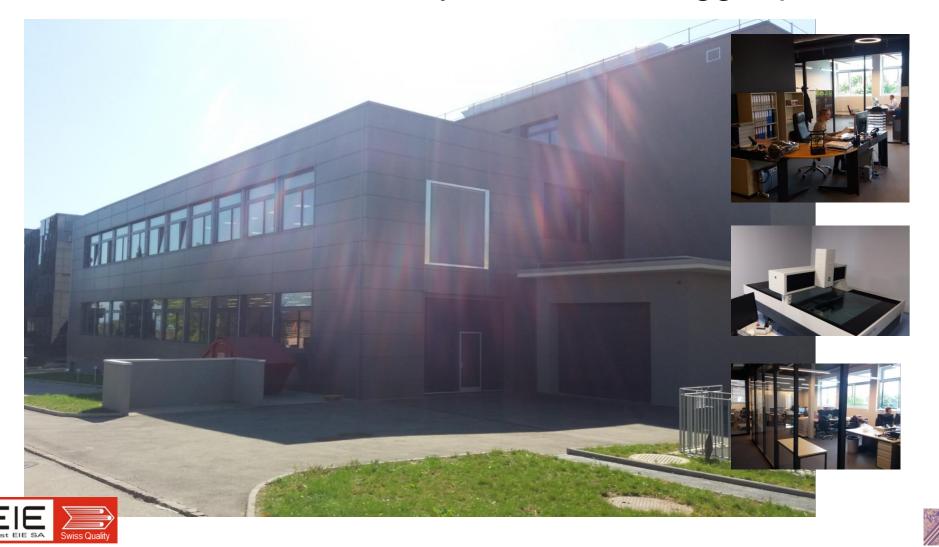
Core Technologies Opto-Electronic, Image Processing, Ink-Jet



We Provide The True Figures through Swiss Quality



First EIE SA already moved to a bigger place





First EIE SA already moved to a bigger place











First EIE SA already moved to bigger a corporate size

- Acquisition of First EIE on 2015
- From imaging to inspection
- Complementary Product Portfolio
- Stronger Synergies



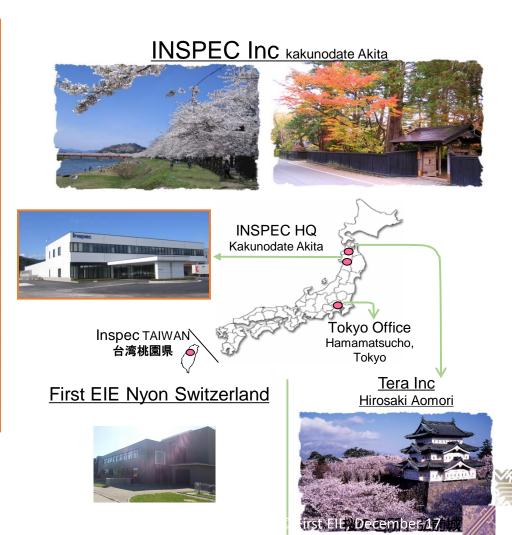
President Mr Masashi Sugawara





First EIE SA already moved to bigger a corporate size

| Name | INSPEC Inc |
|---------------------|---|
| Code | 6656 (Tosyo Mothers) |
| Line of Business | Manufacturing of Visual Inspection Equipment on Electric Cuircuit Board (SemiCon PackageBoard • FPC, etc) and Development Sales Service Medical Equipment manufacturing Development and Sales |
| Head Office | Kakunodate, senboku, Akita Pref |
| Founded | January 1984 |
| Capital | 485mil yen |
| Employee | 43 (as of Apr 30 2015) |
| URL | http://www.inspec21.com |



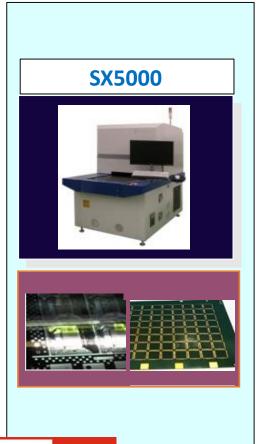




First EIE SA already moved to bigger market

Automatic Optical linspection

Automatic Visual Inspection









15th of March 1999 My fisrt day....

Mr Skynazy, former First EIE President: « Jean-paul, I expect that we will still sell photoplotters for the next five years only. Then everything will be LDI»

Today in 2017, the Silver Halide films and Photoplotter market remain very strong

With higher resolution, higher speed and larger size





Photoplotters: External drums and Flat beds





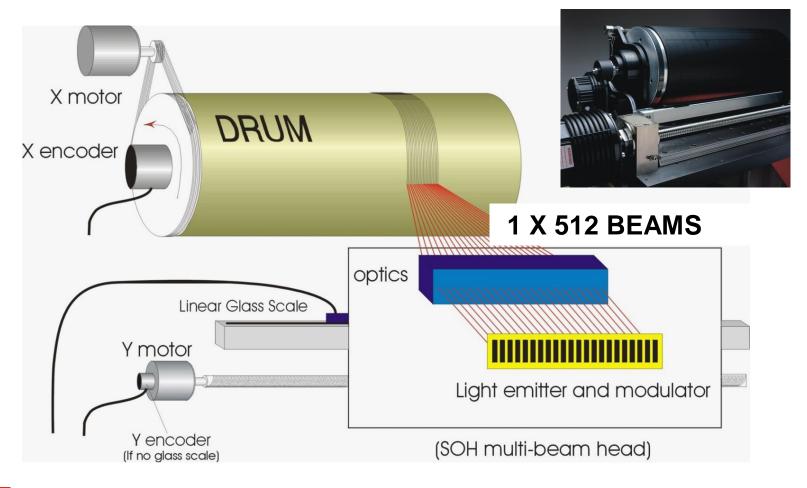








External Drum the must up to 2.4 meters







First EIE SA already moved with bigger Photoplotters



RP1625 2450 x 1600 mm film size 25 000 dpi

4000 mm on the way....

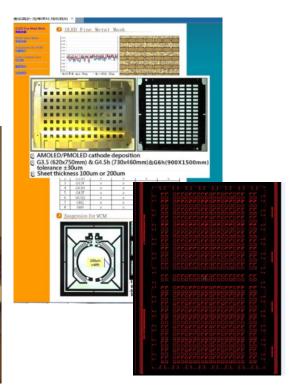


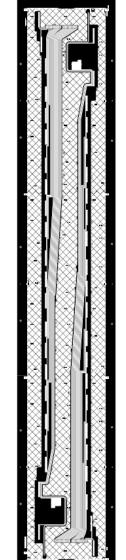




Long PCBs – Rigid or Flexs Shadow mask production **OLED Metal mask production**













Long PCBs – Rigid or Flexs

One UK Supplier: today 26 meters Flex PCB – request for 42 meters

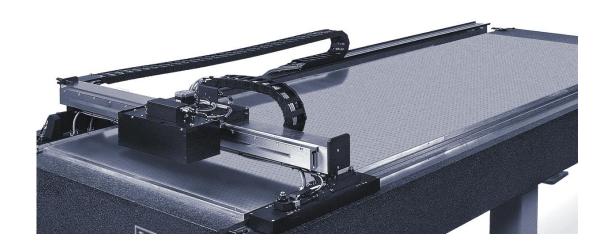
Car and Aircraft: That require Inspection....







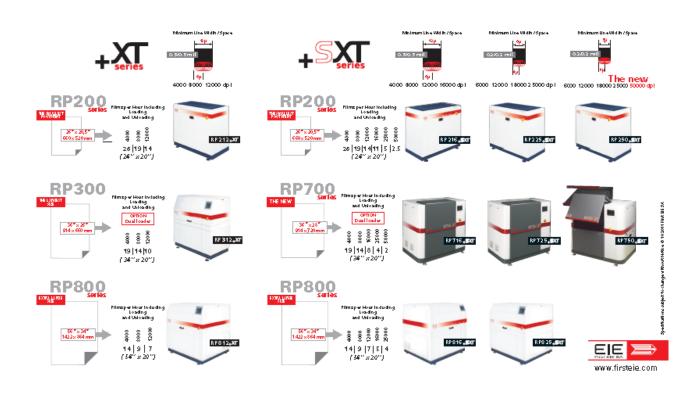
Above 2.4 meters Hudge and heavy Gantry systems Limited overall accuracy







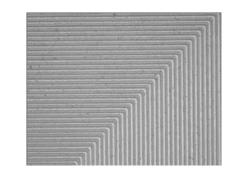
Of course we keep our broad range of Photoplotter





From 20x26 to 63 x 83 " From 3000 to 50000 dpi Down to 5 micron line

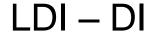
From 90 K to 600 K euros







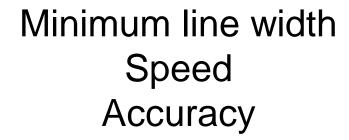




















First EIE already moved to bigger Direct Imager from the established EDI500 model:

EDI500: 720 x 610 mm panel size

EDI700: 1000 x 800 mm panel size

EDI1000 (NDA): 6000 x 1000 mm panels size

Full spectrum: 360 to 450 nm

4 to 1000 mJ/cm2

Local registration

Dynamic serialization





Direct Imager EDI Series



The new EDI700

- HDS or HVS light engine
- Full light spectrum
- 1000x 800 panel size
- Gantry System with Linear motors
- Granite-Glass table with Zone system
- High Accuracy





Simple and efficient

Small footprint

EDI500:150x190x147cm **–** 850 Kgs EDI700: 230x200x170 cm **–** 2400 Kgs

User friendly interface Files management based on 30 years of Imaging experience

Easy Access for maintenance

Cold start: It takes 10 minutes including the UV lamp warming

Machine shut-down is done automatically. It takes less than 1 minute.

X - Y Axis R Axis Rotative table for file to panel Alignement Z Axis for accurate spot size







DMD technology with UV Arc lamp Collimated

One single head: simplicity, reliabily, low cost



360 to 450 nm: ALWAYS!

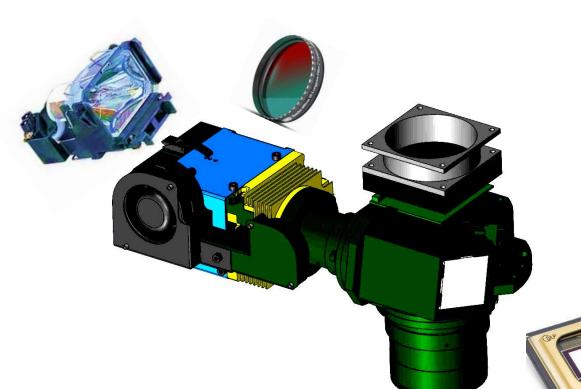








One Single Digital Micro-Mirror-Device Head Just simple and efficient components



- No banding effect
- Easy adjustement
- Easy maintenance
- Cost effective

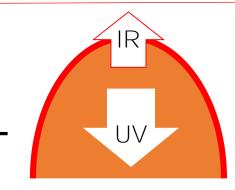




Inkjet Printers - Photoplotter - Direct Imager

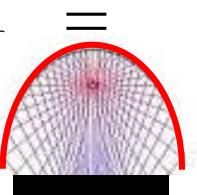






cost efficient and High-Pressure Arc Lamp 330 W Propriatary First EIE Reflector with advanced coating for maximum UV reflection and minimum IR

Arc Lamp life time: over 2000 hours



Low heat

Low consumption

800 VA max during exposure

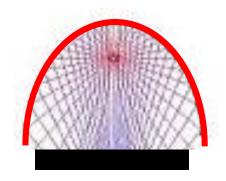
High efficiency

Very High exposure energy to the Panel, from 4 up to 1000 mj









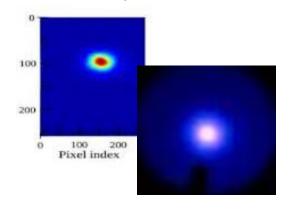


High exposure energy to the DMD



Proprietary First EIE Optics

Sharped 8 micron spot size



Broad Energy

4 to 1000 mj

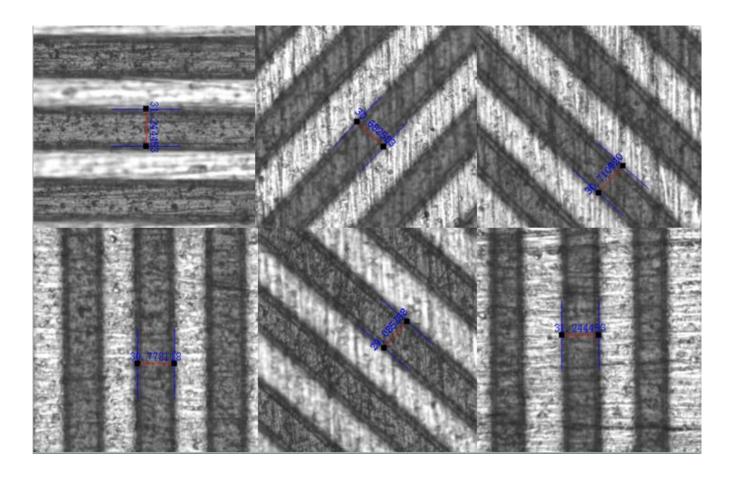
Line width capability

20 micron L/S with HDS



HDS Light Engine

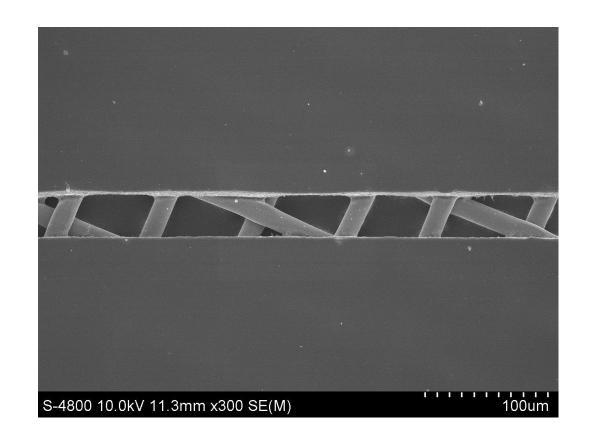
30 micron lines DFR 40 mJ







20 micron lines on 50 micron resist





HDS - HVS Light Engines

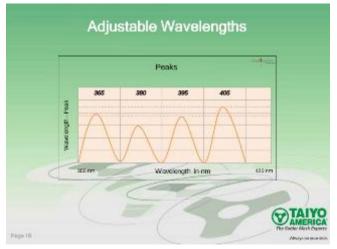




HDS - HVS Light Engines

LEDs: 1 to 4 wave lengths

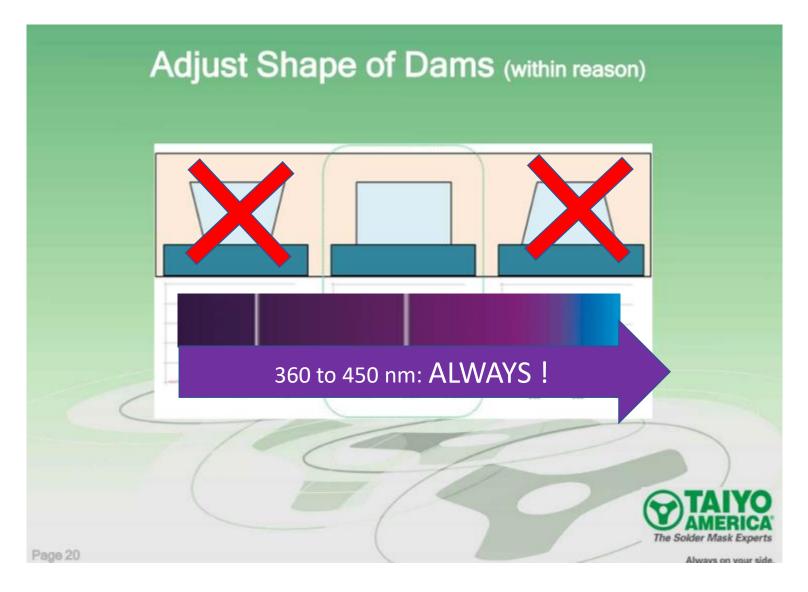






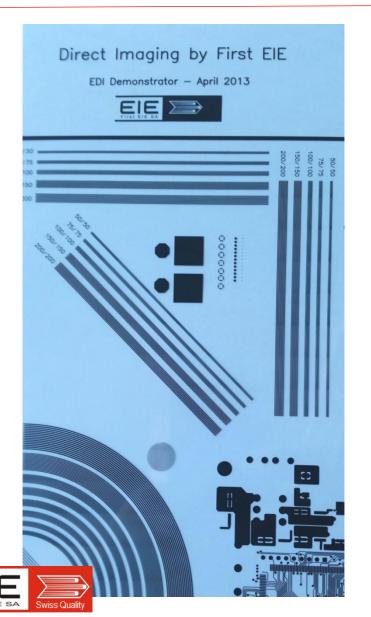


HDS - HVS Light Engines









The EDI500 HDS is able to expose Silver Halide Films

Your Photoplotter back up

Black density > 5

Ask for the reference of the recomended UV sensible Silver Halide Film



Air Cooling & Dust Management

Two big Fans keep the EDI500 HDS enclosure under positive pressure

- Brings cool air from the yellow room (class 100000) and evacuates calories
- Dust free system







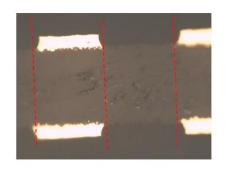
Optional Air Exaust Connection





Registration side A to side B

Dry film PH2050 size 460 x 610 mm



Less than 10 microns registration side A to side B

| X/Y | а | b | С | d | а | b | С | d | а | b | С | d | а | b | |
|--------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|--|
| A1 100/100 | 0,06 | 0,06 | 0,08 | 0,06 | 0,04 | 0,08 | 0,06 | 0,06 | 0,06 | 0,08 | 0,08 | 0,06 | 0,06 | 0,06 | |
| A1 Face arrière | 0,08 | 0,04 | 0,08 | 0,04 | 0,06 | 0,06 | 0,04 | 0,06 | 0,08 | 0,06 | 0,06 | 0,06 | 0,08 | 0,06 | |



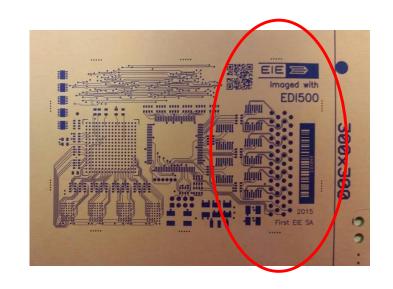




- Dynamic Information via Pads Mapping (D-code)
 - Time code, File/Job name, User Input
 - **PCB Serial number, Panel Serial**
 - 1D or 2D Barcode

Industry 4.0









Even longer with Roll to Roll

AOI and AVI already in production for PCB and components - EDI in development







AV500 Introduction











PCB Product Cost Reduction

Evolution of products

Higher density Finer L/S





Difficulties:

- Increase of labor costs
- Low Yield in Volume Production (Process feedback & Repair data are required)

Requirements:

- Finer defect detection
- 100% inspection but not sampling
- Quality Assurance with data



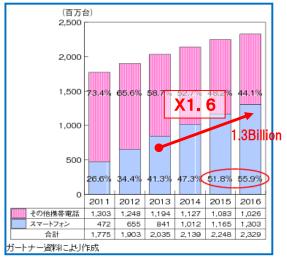
Solution: from VI (human) to AVI (machine vision)

Rapidly increasing of AVI needs

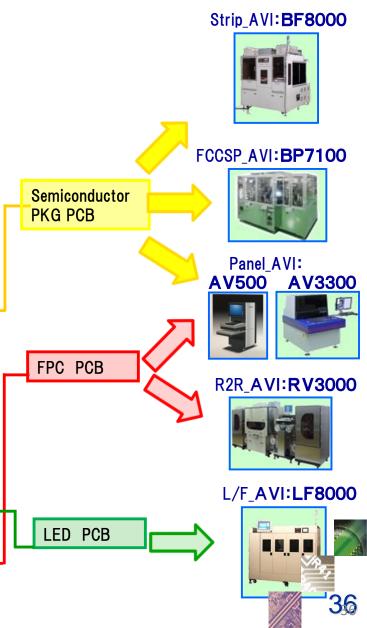


AVI Market Status

World Market Forecasts Smartphone







World Market Forecasts Tablet





Needs of AVI became obvious

Needs of AVI instead of VI

2000~2008

2009~

2013~

Many big factories of Visual inspection appear

- Rapid increase of labor cost
- Since the pattern pitch became narrow, visual inspection got to be difficult.

New needs

High spec and low price **AVI** instead of human inspection.

inspec suggestion

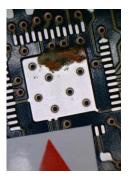
AV500

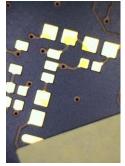




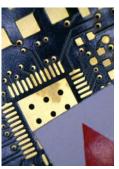
Typical defaults

| Surface Finish | Excess Solder & Solder Sweep Solder Non Wetting Solder residue or solder streeks Gold Void Oxidation on Gold Imm tin Void Stains or Imm tin Dullness | | | | |
|-----------------------|--|--|--|--|--|
| Routing | Step Routing / Dip Routing Missing Slots / Half rout slots Dimentional error & Routing Shift Missing V Groove & V Groove Shift Routing dust & Routing Burrs Water Stains & Water Residues Improper Routing Slots / Shape | | | | |
| Legend & Other Prints | Missing Legend & Illegible Legend Legend Color Mismatch Legend Residues & Legend Shift Carbon Void & Shift Carbon print Shift & Carbon short Peelable Mask Shift & Pellable residue Peelable Mask void | | | | |
| ВВТ | Pad Damage, Pin Impression. | | | | |
| General Defects | Scratches (Anywhere in active area) Foreign Particle on PCBs (Hair, Dust, >50 Microns Sq) Fingure Prints & Oxidation on Surface Damaged Pad / PCBs Brocken Tabs & Edge Damage Paper particals. Residues in Hole | | | | |







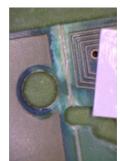


















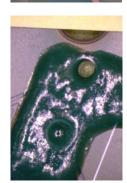


Typical defaults

| Defect Location | Defects Type |
|-----------------------------|--|
| Laminate Defects | Dent, Measlings Spots Delam, Blisters Resin Starvation Weave texure & Weave texure Exposures Crazing Wrinkle & Resin Residue Warpage if possible |
| Photo Process | Discoloration or spots on Copper Copper void on surface (at any active area). Copper residue / treces. Image shift / Misregistration Line width reduction & Line space reduction |
| Mechanical Drilling defects | Drill Hole Damage Drill Shift / Misregistration / Single hole offset Missing & Extra Hole Half Drill & Contour Wrong hole Diameter (reduction or increase in hole size) |
| Copper Plating | Copper Nodule on Surface / Rough Plating on surface Missing Copper in Hole (Copper Void) Tin Rsidues |
| Soldermask | Soldermask Void Soldermask Peel off Soldermask residue Thin & Excess Soldermask Soldermask Discoloration & Spots Bubles in Soldermask (Air Pocket) |







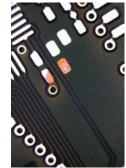




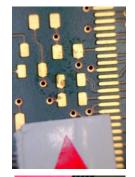










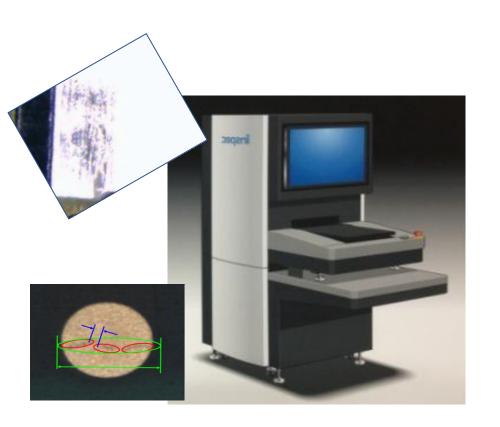








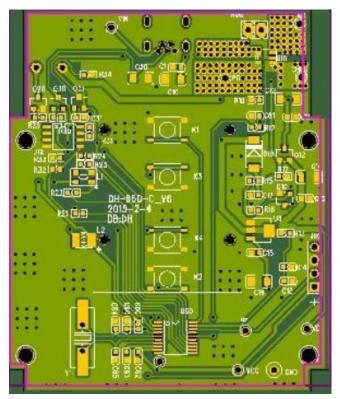
AVI500 visual inspection after final cleaning....

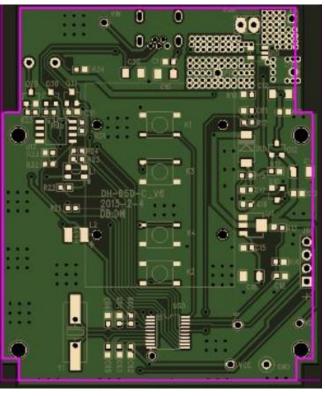


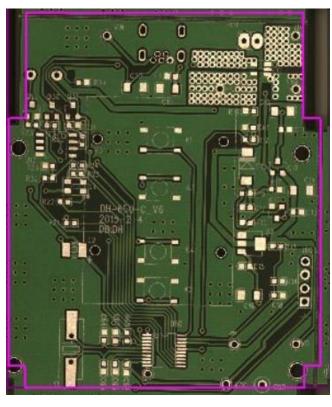
| Human inspection | AVI500 | | | | |
|--------------------------------------|--------------------------------------|--|--|--|--|
| 90sec (Both side) | 30sec (Both side with rotation time) | | | | |
| 240 x 240 | | | | | |
| defect size from 20 to 40 micron | | | | | |
| Scratchs-corrosion-dust-decoloration | | | | | |



Feature – 4: Master Image Creation







CAD data Created master Real sample

Master image can be made from only 1 real sample. No need to choose "Golden sample" Color information at each part (Pad ,SR character etc.) can be capture from real sample.





Thank you very much !!

